



Docket No.: H0498.70155US00  
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hong Yang et al.  
Serial No.: 09/940,072  
Confirmation No.: 3068  
Filed: August 27, 2001  
For: FABRICATION OF CERAMIC MICROSTRUCTURES  
Examiner: C. N. Lopez  
Art Unit: 1731

Certificate of Mailing Under 37 CFR 1.8(a)	
I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as First Class Mail, in an envelope addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.	
Dated: 11/24/07	Signature: <i>[Handwritten Signature]</i> Angela M. Gr. Bth

AMENDMENT AFTER ALLOWANCE UNDER 37 C.F.R. 1.312

OK  
Mail Stop Issue Fee  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

To  
En for  
CL  
Applicants respectfully request entry of this amendment under 37 C.F.R. §1.312.

The Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 11 of this paper.